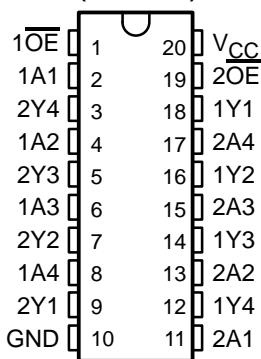
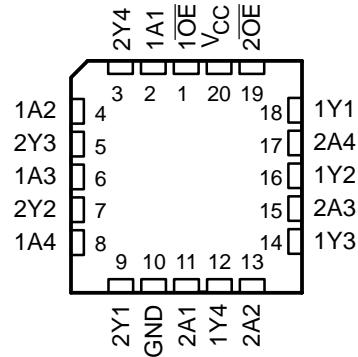


- Operating Voltage Range of 4.5 V to 5.5 V
- State-of-the-Art BiCMOS Design  
Significantly Reduces  $I_{CCZ}$
- 3-State Outputs Drive Bus Lines or Buffer  
Memory Address Registers
- ESD Protection Exceeds JESD 22  
– 2000-V Human-Body Model (A114-A)

SN54BCT240 . . . J OR W PACKAGE  
SN74BCT240 . . . DB, DW, N, OR NS PACKAGE  
(TOP VIEW)



SN54BCT240 . . . FK PACKAGE  
(TOP VIEW)



### description/ordering information

These octal buffers and line drivers are designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. Together with the 'BCT241 and 'BCT244 devices, these devices provide the choice of selected combinations of inverting and noninverting outputs, symmetrical  $\overline{OE}$  (active-low output-enable) inputs, and complementary OE and  $\overline{OE}$  inputs. These devices feature high fan-out and improved fan-in.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

### ORDERING INFORMATION

TA	PACKAGE <sup>†</sup>		ORDERABLE PART NUMBER	TOP-SIDE MARKING
0°C to 70°C	PDIP – N	Tube	SN74BCT240N	SN74BCT240N
	SOIC – DW	Tube	SN74BCT240DW	BCT240
		Tape and reel	SN74BCT240DWR	
	SOP – NS	Tape and reel	SN74BCT240NSR	BCT240
-55°C to 125°C	SSOP – DB	Tape and reel	SN74BCT240DBR	BT240
	CDIP – J	Tube	SNJ54BCT240J	SNJ54BCT240J
	CFP – W	Tube	SNJ54BCT240W	SNJ54BCT240W
	LCCC – FK	Tube	SNJ54BCT240FK	SNJ54BCT240FK

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



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On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

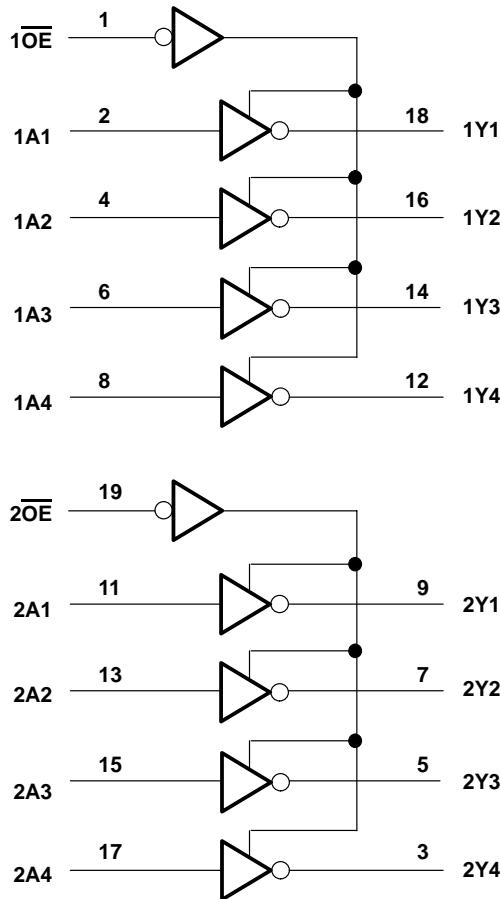
**SN54BCT240, SN74BCT240  
OCTAL BUFFERS/DRIVERS  
WITH 3-STATE OUTPUTS**

SCBS004F – OCTOBER 1987 – REVISED MARCH 2003

**FUNCTION TABLE**  
(each buffer)

INPUTS		OUTPUT
$\overline{OE}$	A	Y
L	H	L
L	L	H
H	X	Z

**logic diagram (positive logic)**



**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†**

Supply voltage range, $V_{CC}$ .....	–0.5 V to 7 V		
Input voltage range, $V_I$ (see Note 1) .....	–0.5 V to 7 V		
Voltage range applied to any output in the disabled or power-off state, $V_O$ .....	–0.5 V to 5.5 V		
Voltage range applied to any output in the high state, $V_O$ .....	–0.5 V to $V_{CC}$		
Input clamp current, $I_{IK}$ .....	–30 mA		
Current into any output in the low state: SN54BCT240 .....	96 mA		
SN74BCT240 .....	128 mA		
Package thermal impedance, $\theta_{JA}$ (see Note 2): DB package .....	70°C/W		
DW package .....	58°C/W		
N package .....	69°C/W		
NS package .....	60°C/W		
Storage temperature range, $T_{stg}$ .....	–65°C to 150°C		

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.  
 2. The package thermal impedance is calculated in accordance with JESD 51-7.

**recommended operating conditions (see Note 3)**

		SN54BCT240			SN74BCT240			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
$V_{CC}$	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
$V_{IH}$	High-level input voltage		2			2		V
$V_{IL}$	Low-level input voltage			0.8			0.8	V
$I_{IK}$	Input clamp current			–18			–18	mA
$I_{OH}$	High-level output current			–12			–15	mA
$I_{OL}$	Low-level output current			48			64	mA
$T_A$	Operating free-air temperature	–55		125	0		70	°C

NOTE 3: All unused inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

**SN54BCT240, SN74BCT240  
OCTAL BUFFERS/DRIVERS  
WITH 3-STATE OUTPUTS**

SCBS004F – OCTOBER 1987 – REVISED MARCH 2003

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER	TEST CONDITIONS	SN54BCT240			SN74BCT240			UNIT
		MIN	TYP†	MAX	MIN	TYP†	MAX	
$V_{IK}$	$V_{CC} = 4.5 \text{ V}$ , $I_I = -18 \text{ mA}$			-1.2			-1.2	V
$V_{OH}$	$V_{CC} = 4.5 \text{ V}$	$I_{OH} = -3 \text{ mA}$	2.4	3.3	2.4	3.3		V
		$I_{OH} = -12 \text{ mA}$	2	3.2				
		$I_{OH} = -15 \text{ mA}$			2	3.1		
$V_{OL}$	$V_{CC} = 4.5 \text{ V}$	$I_{OL} = 48 \text{ mA}$	0.38	0.55				V
		$I_{OL} = 64 \text{ mA}$			0.42	0.55		
$I_I$	$V_{CC} = 5.5 \text{ V}$ , $V_I = 7 \text{ V}$			0.1			0.1	mA
$I_{IH}$	$V_{CC} = 5.5 \text{ V}$ , $V_I = 2.7 \text{ V}$			20			20	$\mu\text{A}$
$I_{IL}$	$V_{CC} = 5.5 \text{ V}$ , $V_I = 0.5 \text{ V}$			-1			-1	mA
$I_{OZH}$	$V_{CC} = 5.5 \text{ V}$ , $V_O = 2.7 \text{ V}$			50			50	$\mu\text{A}$
$I_{OZL}$	$V_{CC} = 5.5 \text{ V}$ , $V_O = 0.5 \text{ V}$			-50			-50	$\mu\text{A}$
$I_{OS}^{\ddagger}$	$V_{CC} = 5.5 \text{ V}$ , $V_O = 0$		-100	-225	-100	-225		mA
$I_{CCH}$	$V_{CC} = 5.5 \text{ V}$ , Outputs open		19	31	19	31		mA
$I_{CCL}$	$V_{CC} = 5.5 \text{ V}$ , Outputs open		46	71	46	71		mA
$I_{CCZ}$	$V_{CC} = 5.5 \text{ V}$ , Outputs open		6	9	6	9		mA
$C_i$	$V_{CC} = 5 \text{ V}$ , $V_I = 2.5 \text{ V} \text{ or } 0.5 \text{ V}$		6		6			pF
$C_o$	$V_{CC} = 5 \text{ V}$ , $V_O = 2.5 \text{ V} \text{ or } 0.5 \text{ V}$		11		11			pF

† All typical values are at  $V_{CC} = 5 \text{ V}$ .

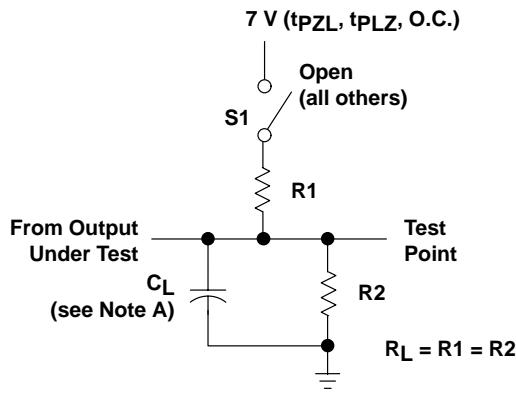
‡ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

**switching characteristics (see Figure 1)**

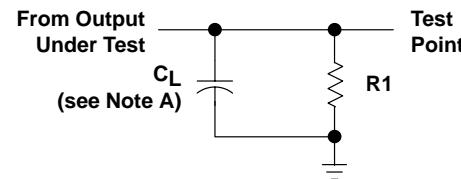
PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 5 \text{ V}$ , $C_L = 50 \text{ pF}$ , $R1 = 500 \Omega$ , $R2 = 500 \Omega$ , $T_A = 25^\circ\text{C}$	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ , $C_L = 50 \text{ pF}$ , $R1 = 500 \Omega$ , $R2 = 500 \Omega$ , $T_A = \text{MIN to MAX}^{\$}$			UNIT	
			'BCT240			SN54BCT240	SN74BCT240	
			MIN	TYP	MAX	MIN	MAX	
			0.5	3.3	4.8	0.5	6.4	0.5 5.6
$t_{PLH}$	A	Y	0.4	1.8	3.5	0.4	4.5	0.4 4
$t_{PHL}$			1	6.4	7.9	1	9.2	1 8.8
$t_{PZH}$	$\overline{OE}$	Y	1	7.5	9.4	1	10.8	1 10.5
$t_{PZL}$			1	6	6.8	1	8.5	1 8.1
$t_{PHZ}$	$\overline{OE}$	Y	1	6.7	8.1	1	10.6	1 9.5
$t_{PLZ}$								

§ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

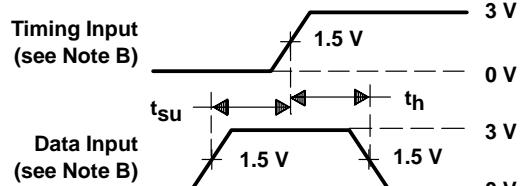
PARAMETER MEASUREMENT INFORMATION



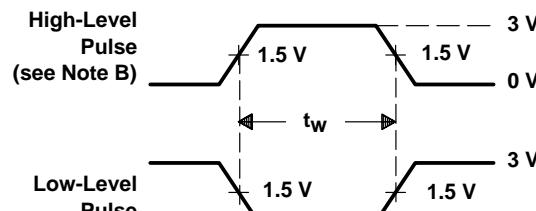
LOAD CIRCUIT FOR  
3-STATE AND OPEN-COLLECTOR OUTPUTS



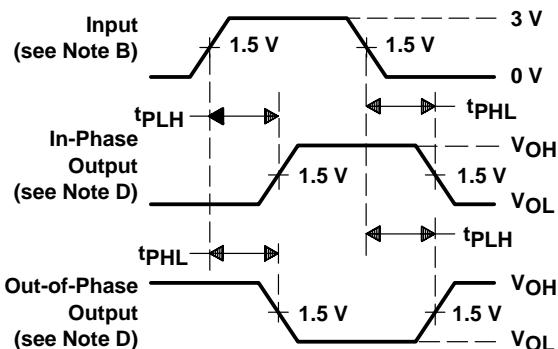
LOAD CIRCUIT FOR  
TOTEM-POLE OUTPUTS



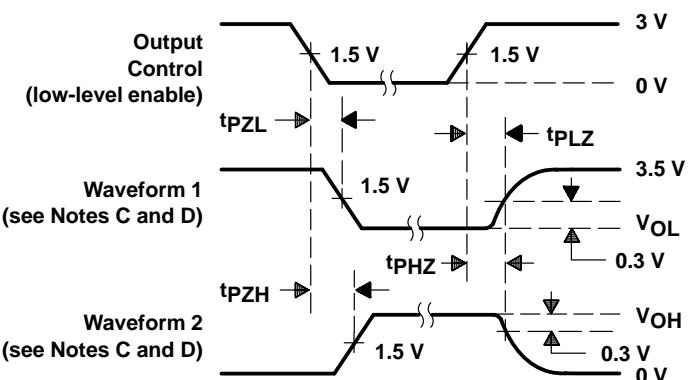
VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES (see Note D)



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS

NOTES:

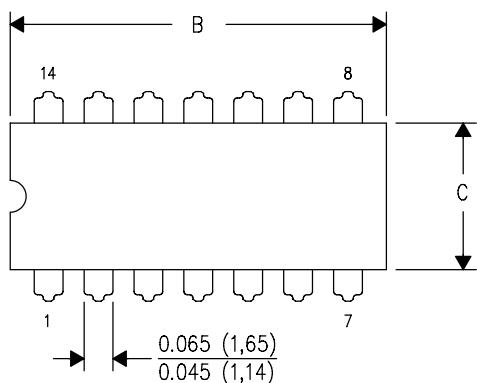
- C<sub>L</sub> includes probe and jig capacitance.
- All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, t<sub>r</sub> = t<sub>f</sub>  $\leq$  2.5 ns, duty cycle = 50%.
- Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- The outputs are measured one at a time with one transition per measurement.
- When measuring propagation delay times of 3-state outputs, switch S1 is open.
- All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

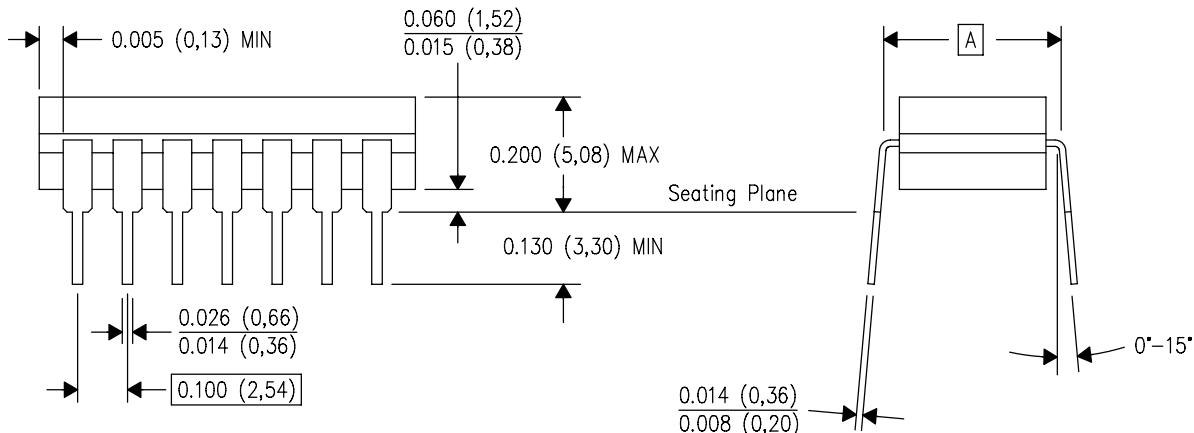
J (R-GDIP-T\*\*)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



PINS ** DIM	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)

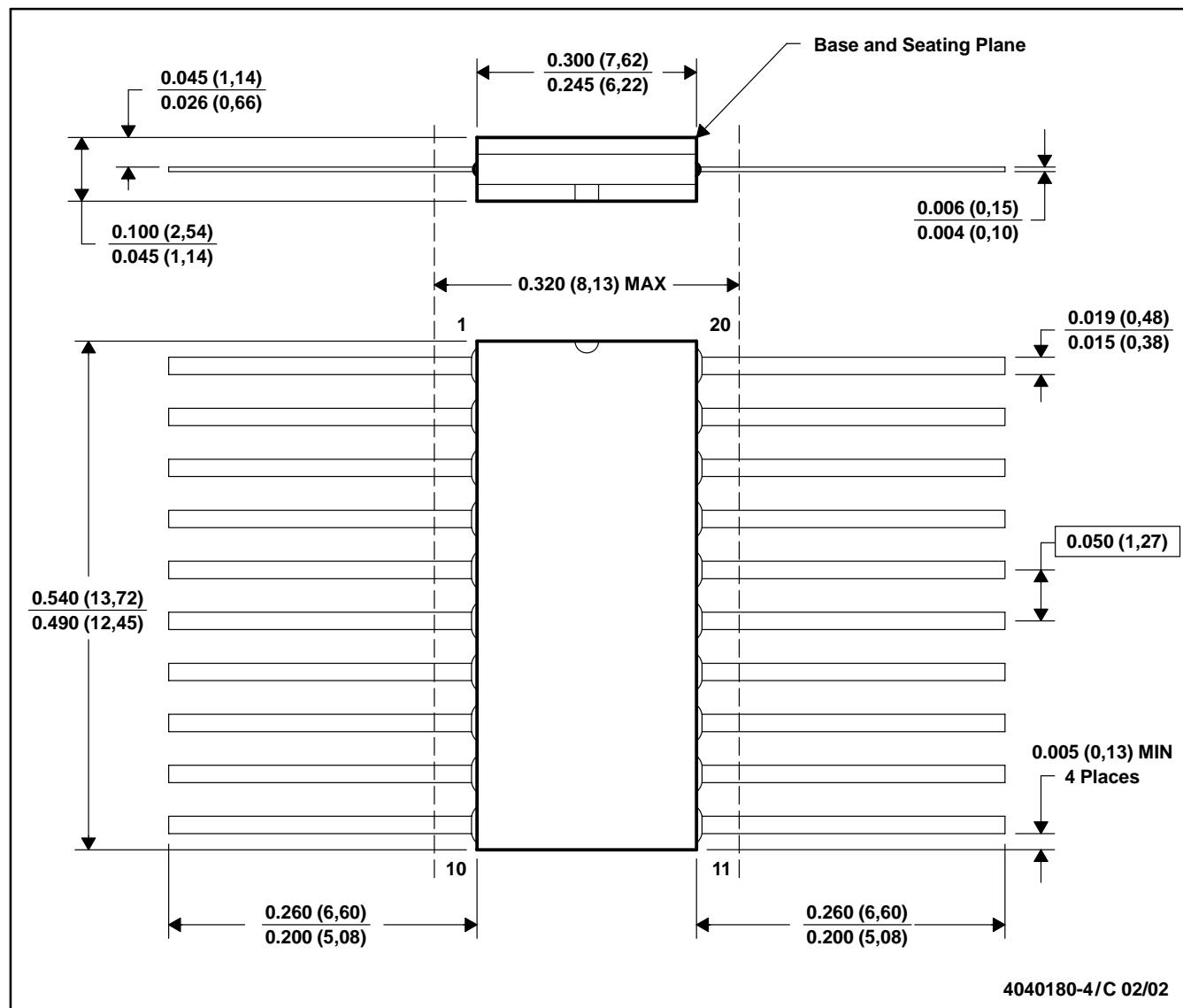


4040083/F 03/03

NOTES: A. All linear dimensions are in inches (millimeters).  
B. This drawing is subject to change without notice.  
C. This package is hermetically sealed with a ceramic lid using glass frit.  
D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.  
E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F20)

CERAMIC DUAL FLATPACK



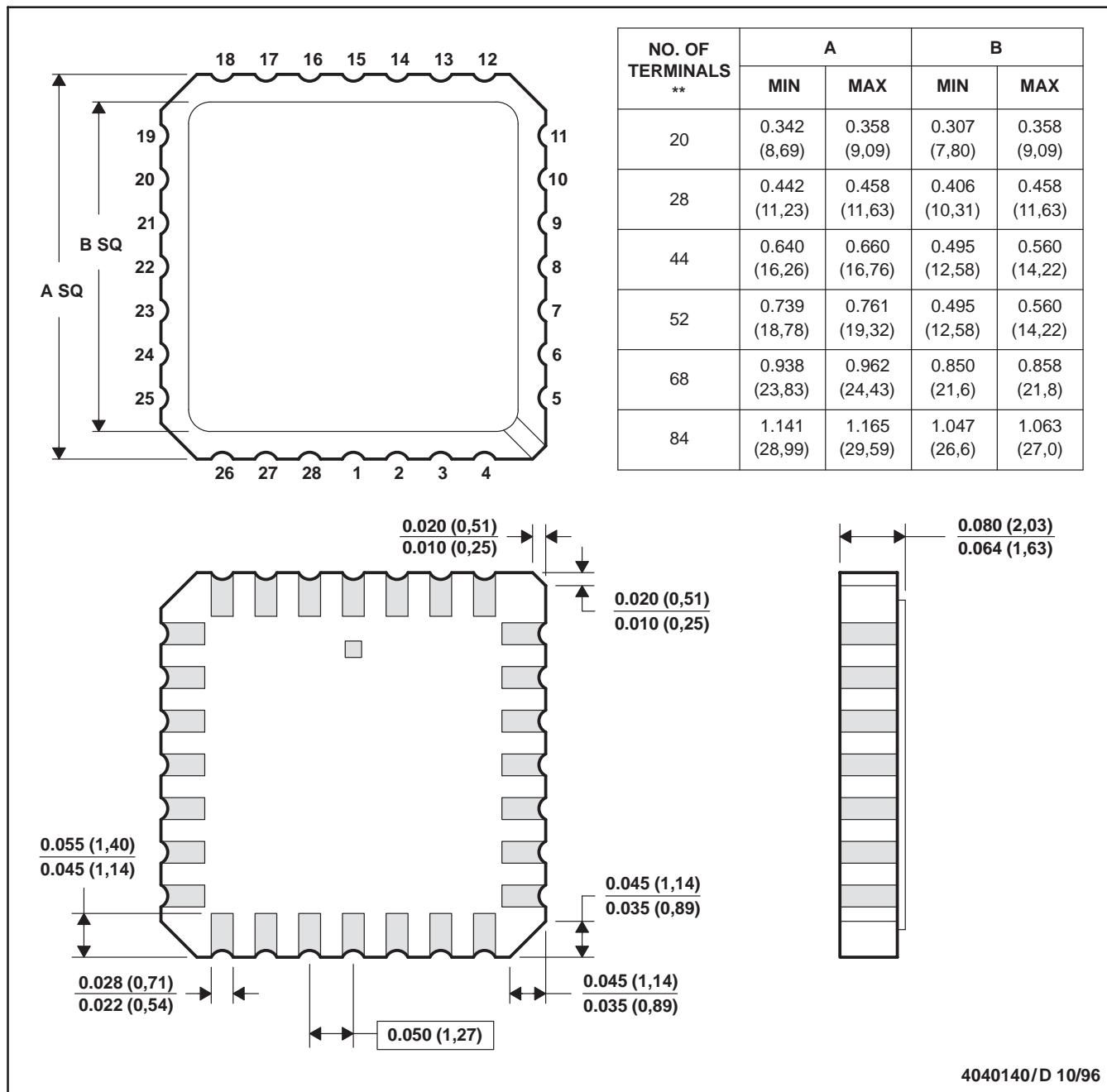
NOTES:

- All linear dimensions are in inches (millimeters).
- This drawing is subject to change without notice.
- This package can be hermetically sealed with a ceramic lid using glass frit.
- Index point is provided on cap for terminal identification only.

## FK (S-CQCC-N\*\*)

## LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. This package can be hermetically sealed with a metal lid.

D. The terminals are gold plated.

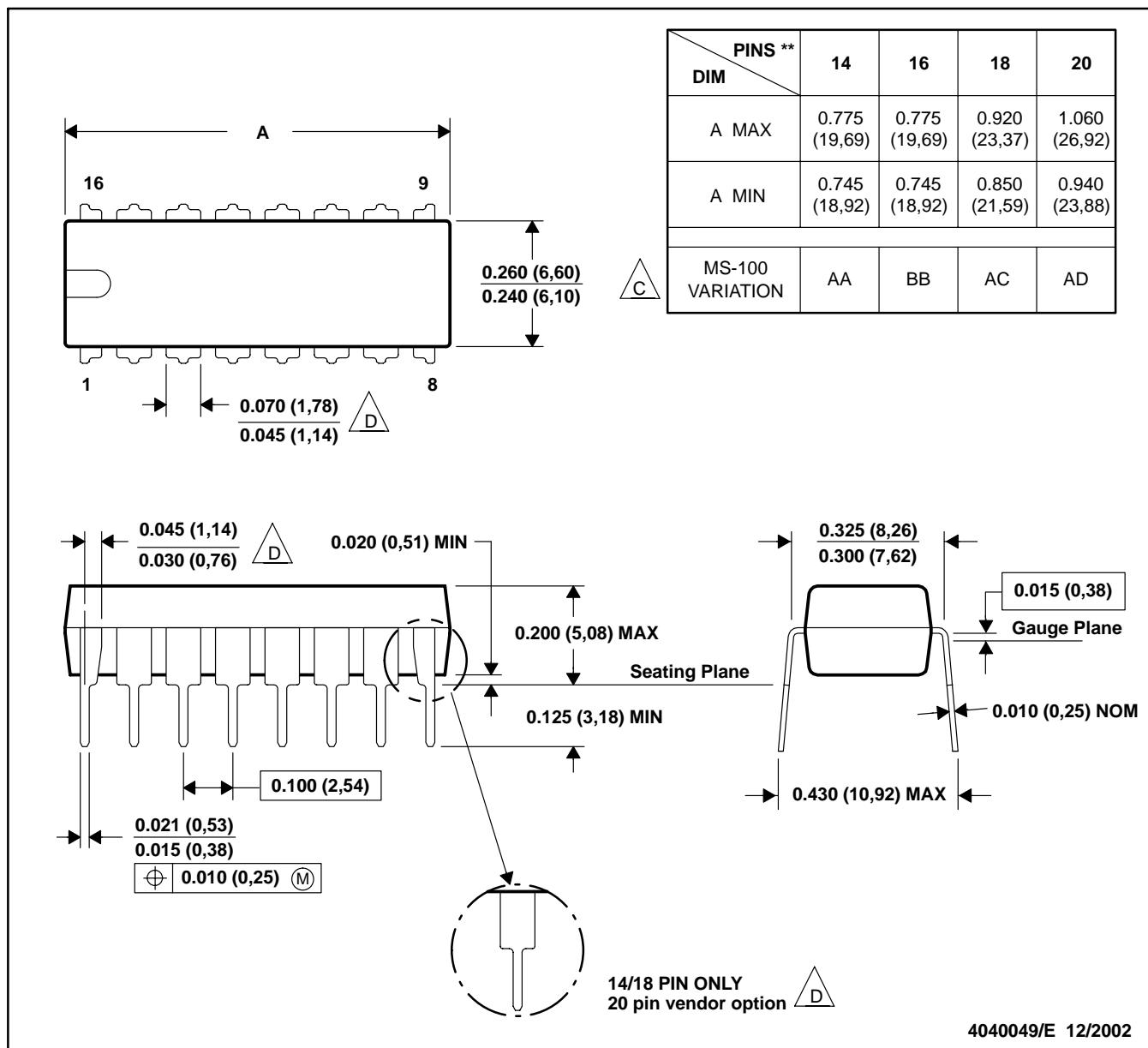
E. Falls within JEDEC MS-004

4040140/D 10/96

N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

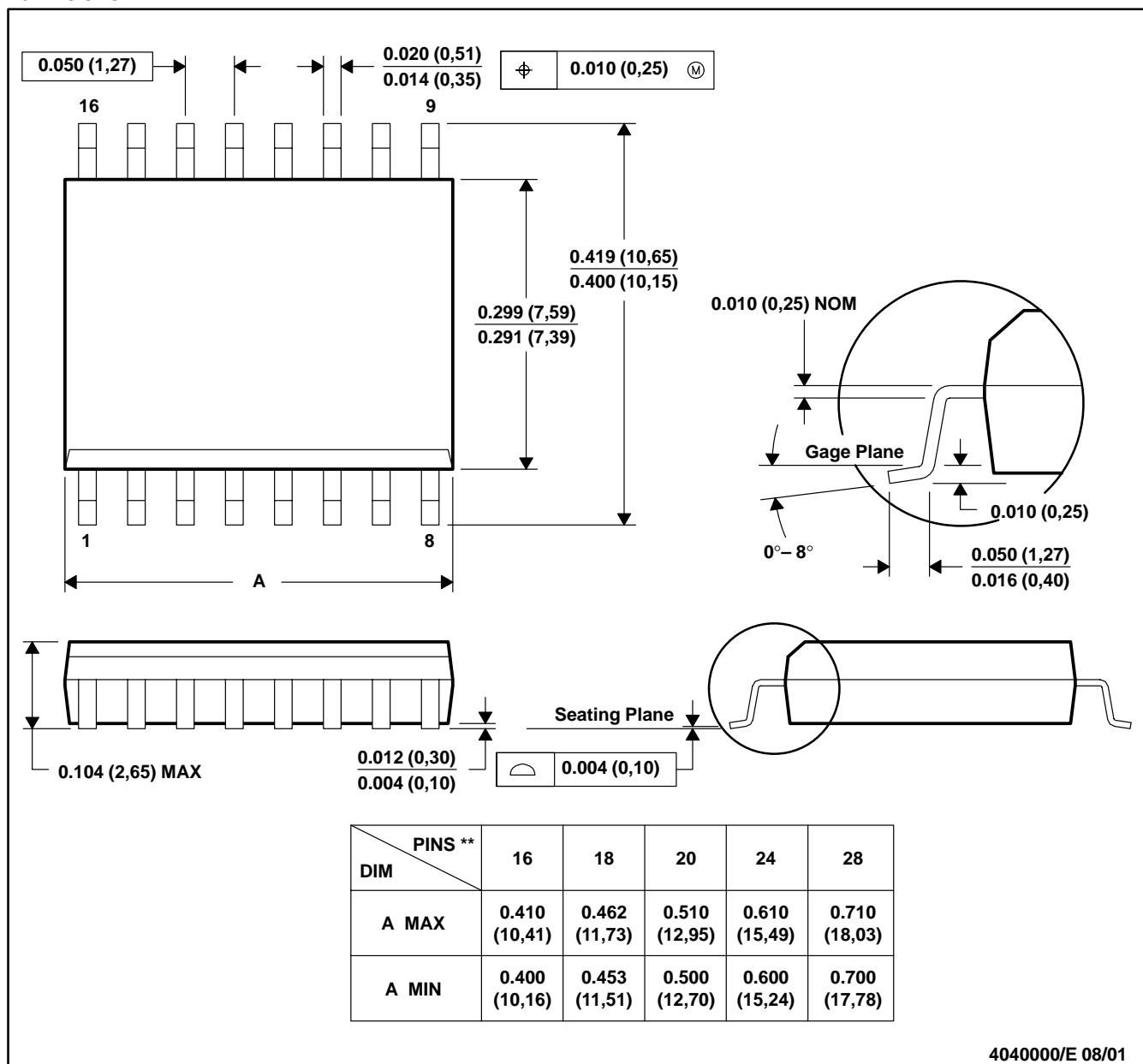
C. Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).

D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

## DW (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

16 PINS SHOWN



4040000/E 08/01

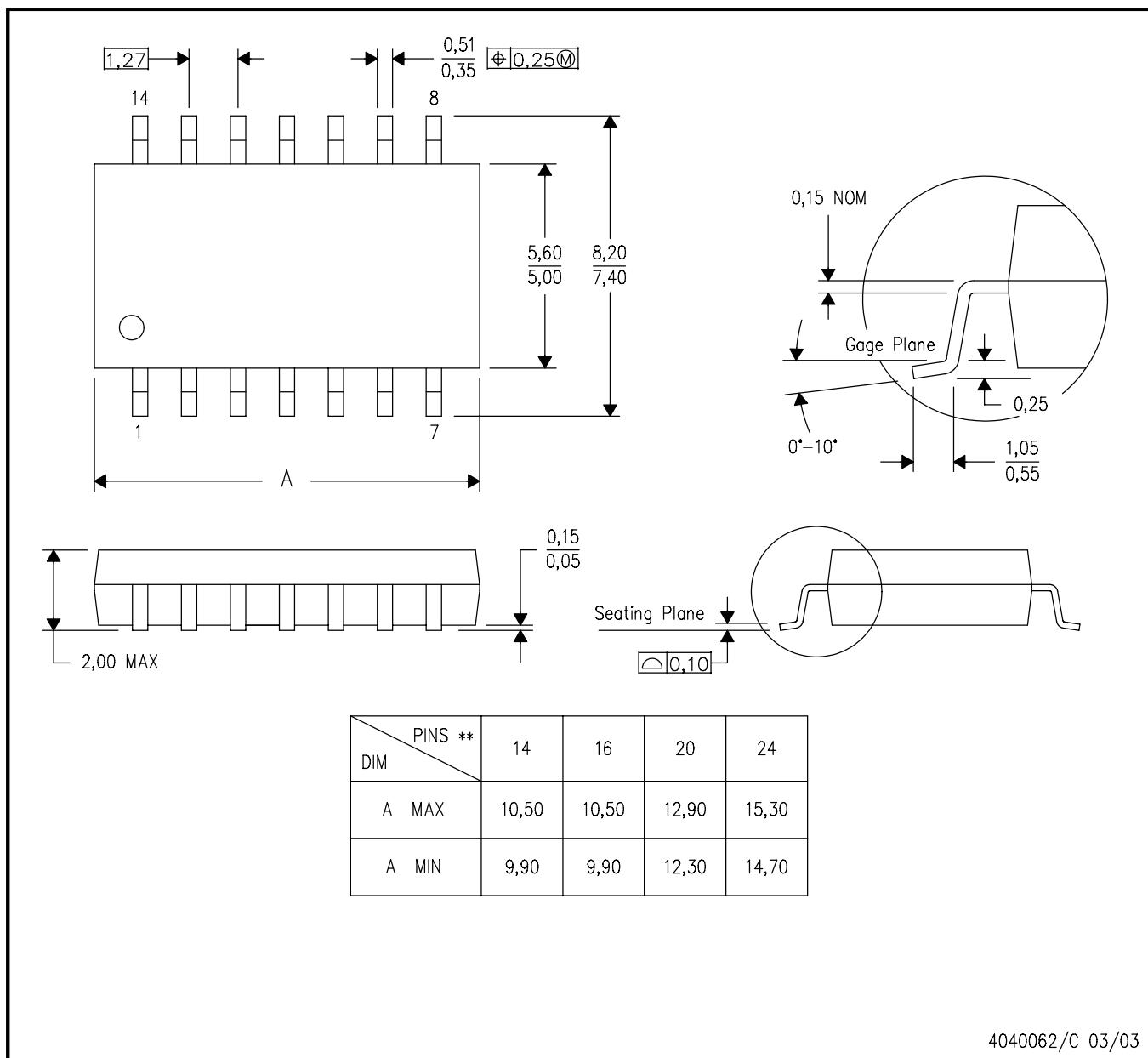
NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0.15).  
 D. Falls within JEDEC MS-013

## MECHANICAL DATA

NS (R-PDSO-G\*\*)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



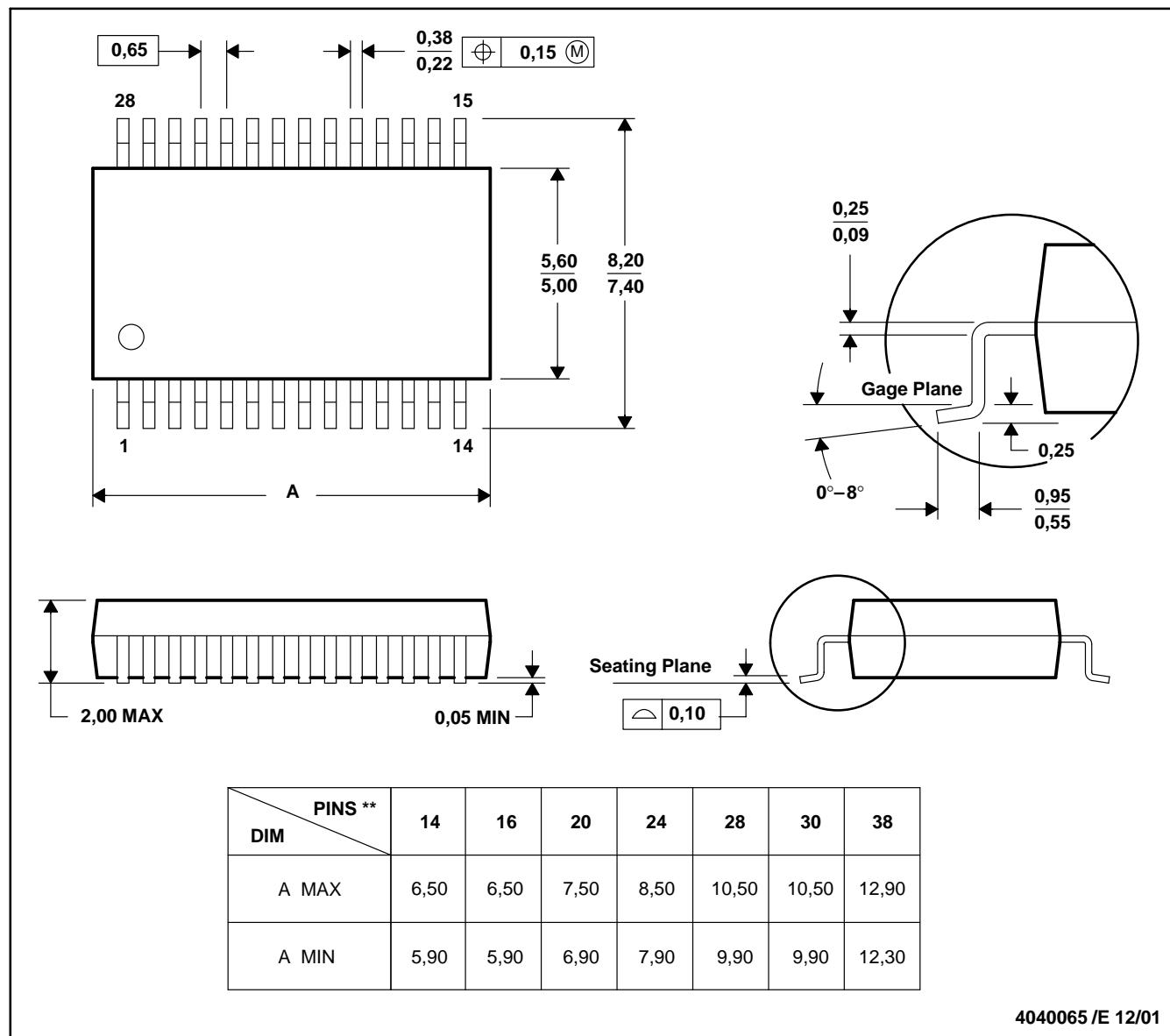
4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

## DB (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-150

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